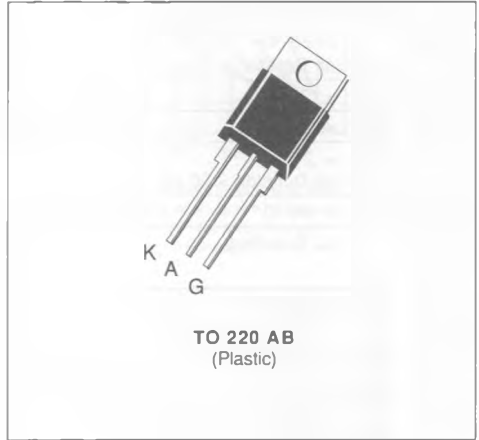


**THYRISTORS**

- GLASS PASSIVATED CHIP
- POSSIBILITY OF MOUNTING ON PRINTED CIRCUIT


**DESCRIPTION**

SCR 's designed for motor control, heating controls, power supplies...

**ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state Current (1)	$T_c = 90^\circ C$	16	A
$I_{T(AV)}$	Mean on-state Current (1)	$T_c = 90^\circ C$	10	A
$I_{TSM}$	Non Repetitive Surge Peak on-state Current ( $T_j$ initial = $25^\circ C$ ) (2)	$t = 8.3$ ms	167	A
		$t = 10$ ms	160	
$I^2t$	$I^2t$ Value for Fusing	$t = 10$ ms	128	A <sup>2</sup> s
di/dt	Critical Rate of Rise of on-state Current (3)		100	A/ $\mu$ s
$T_{stg}$	Storage and Operating Junction Temperature Range		- 40 to 125	$^\circ C$
$T_j$			- 40 to 125	$^\circ C$

Symbol	Parameter	TYN						Unit
		0516	116	216	416	616	816	
$V_{DRM}$ $V_{RRM}$	Repetitive Peak off-state Voltage (4)	50	100	200	400	600	800	V

(1) Single phase circuit,  $180^\circ$  conduction angle.

(2) Half sine wave.

(3)  $I_G = 250$  mA  $di/dt = 1$  A/ $\mu$ s.

(4)  $T_j = 125^\circ C$ .

**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction-case for D.C.	2.5	$^\circ C/W$
$R_{th(j-a)}$	Junction-ambient	60	$^\circ C/W$

**GATE CHARACTERISTICS** (maximum values)

$P_{GM} = 20 \text{ W}$  ( $t_p = 20 \mu\text{s}$ )

$I_{FGM} = 2 \text{ A}$  ( $t_p = 20 \mu\text{s}$ )

$V_{RGM} = 5 \text{ V}$

$P_G(AV) = 0.5 \text{ W}$

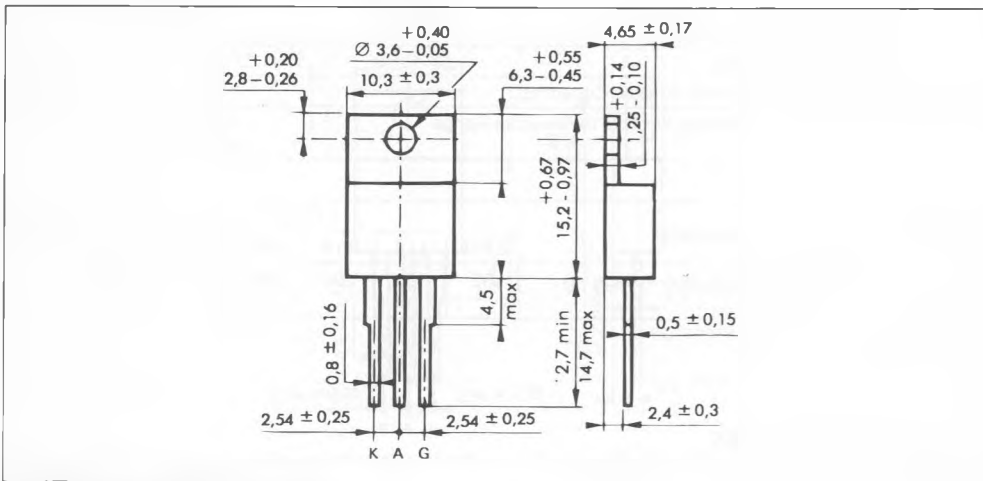
$V_{FGM} = 15 \text{ V}$  ( $t_p = 20 \mu\text{s}$ )

**ELECTRICAL CHARACTERISTICS**

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
$I_{GT}$	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 $\mu\text{s}$	$V_D = 12 \text{ V}$	$R_L = 33 \text{ } \Omega$			25	mA
$V_{GT}$	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 $\mu\text{s}$	$V_D = 12 \text{ V}$	$R_L = 33 \text{ } \Omega$			1.5	V
$V_{GD}$	$T_j = 125 \text{ }^\circ\text{C}$	$V_D = V_{DRM}$	$R_L = 3.3 \text{ k}\Omega$	0.2			V
$I_H$	$T_j = 25 \text{ }^\circ\text{C}$	$I_T = 100 \text{ mA}$	Gate Open			40	mA
$I_L$	$T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 $\mu\text{s}$	$V_D = 12 \text{ V}$	$I_G = 50 \text{ mA}$		70		mA
$V_{TM}$	$T_j = 25 \text{ }^\circ\text{C}$	$I_{TM} = 32 \text{ A}$	$t_p = 10 \text{ ms}$			1.6	V
$I_{DRM}$	$V_{DRM}$ Specified			$T_j = 25 \text{ }^\circ\text{C}$		0.01	mA
				$T_j = 125 \text{ }^\circ\text{C}$		2	
$I_{RRM}$	$V_{RRM}$ Specified			$T_j = 25 \text{ }^\circ\text{C}$		0.01	mA
				$T_j = 125 \text{ }^\circ\text{C}$		2	
$t_{gt}$	$T_j = 25 \text{ }^\circ\text{C}$ $I_G = 80 \text{ mA}$	$V_D = V_{DRM}$ $di_G/dt = 0.85 \text{ A}/\mu\text{s}$	$I_T = 32 \text{ A}$		2		$\mu\text{s}$
$t_g$	$T_j = 125 \text{ }^\circ\text{C}$ $V_D = 67 \% V_{DRM}$ Gate Open	$I_T = 32 \text{ A}$ $di/dt = 30 \text{ A}/\mu\text{s}$	$V_R = 25 \text{ V}$ $dv/dt = 50 \text{ V}/\mu\text{s}$		70		$\mu\text{s}$
$dv/dt^*$	$T_j = 125 \text{ }^\circ\text{C}$	Gate Open Linear Slope up to $V_D = 67 \% V_{DRM}$		500			V/ $\mu\text{s}$

\* For higher guaranteed values, please consult us.

**PACKAGE MECHANICAL DATA : TO 220 AB Plastic**



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g

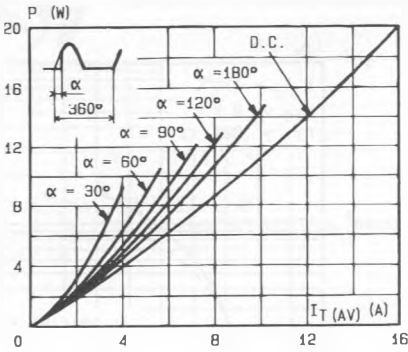


Fig. 1 - Maximum mean power dissipation versus mean on-state current.

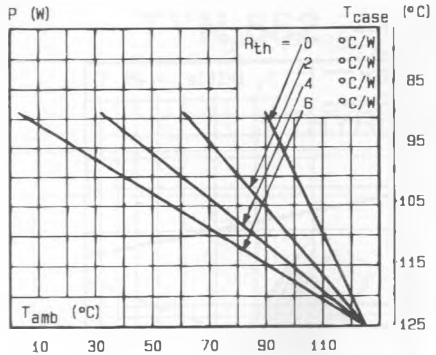


Fig. 2 - Correlation between maximum mean power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.

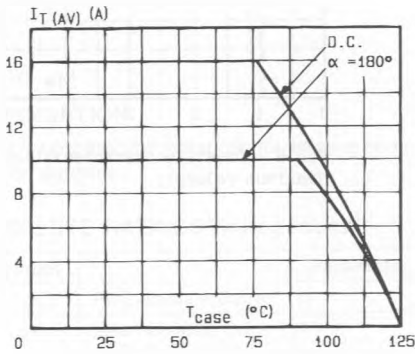


Fig. 3 - Mean on-state current versus case temperature.

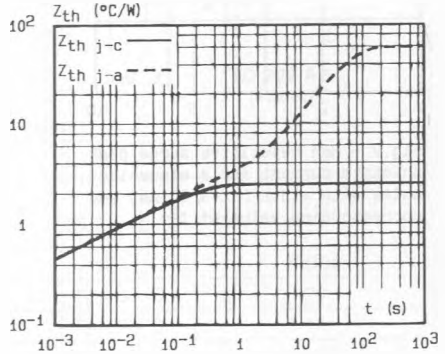


Fig. 4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

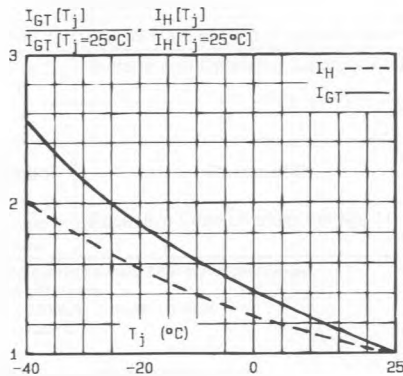


Fig. 5 - Relative variation of gate trigger current and holding current versus junction temperature.

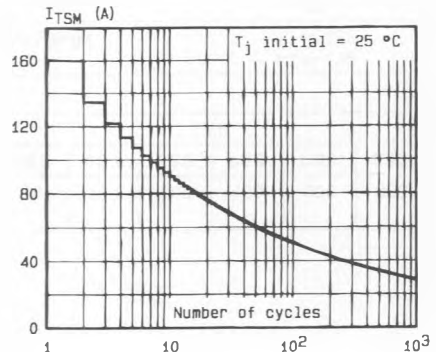


Fig. 6 - Non repetitive surge peak on-state current versus number of cycles.

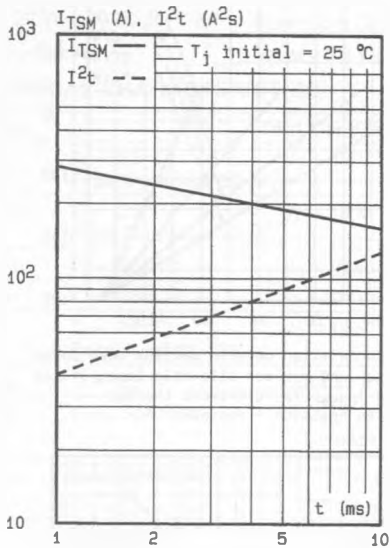


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width:  $t \leq 10$  ms, and corresponding value of  $I^2t$ .

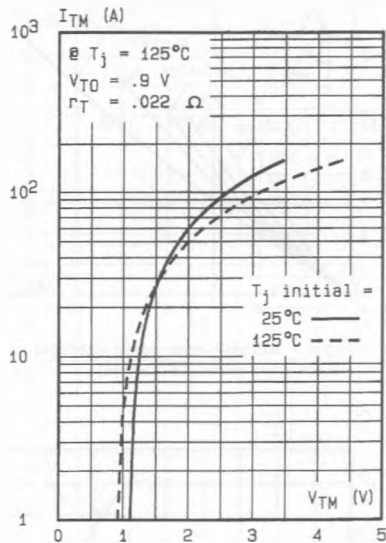


Fig.8 - On-state characteristics (maximum values).